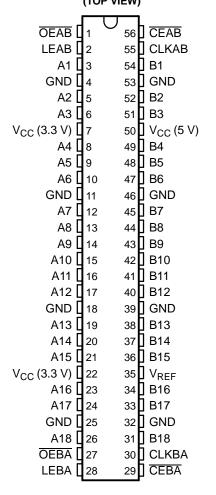
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#### **FEATURES**

- Members of Texas Instruments Widebus™ Family
- UBT<sup>™</sup> Transceivers Combine D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Modes
- OEC<sup>™</sup> Circuitry Improves Signal Integrity and Reduces Electromagnetic Interference
- Translate Between GTL/GTL+ Signal Levels and LVTTL Logic Levels
- Support Mixed-Mode (3.3 V and 5 V) Signal Operation on A-Port and Control Inputs
- Identical to '16601 Function
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors on A Port
- Distributed V<sub>CC</sub> and GND Pins Minimize High-Speed Switching Noise
- Latch-Up Performance Exceeds 500 mA Per JESD 17

#### SN54GTL16612... WD PACKAGE SN74GTL16612... DGG OR DL PACKAGE (TOP VIEW)



#### DESCRIPTION/ORDERING INFORMATION

The 'GTL16612 devices are 18-bit UBT™ transceivers that provide LVTTL-to-GTL/GTL+ and GTL/GTL+-to-LVTTL signal-level translation. They combine D-type flip-flops and D-type latches to allow for transparent, latched, clocked, and clock-enabled modes of data transfer identical to the '16601 function. The devices provide an interface between cards operating at LVTTL logic levels and a backplane operating at GTL/GTL+ signal levels. Higher-speed operation is a direct result of the reduced output swing (<1 V), reduced input threshold levels, and OEC™ circuitry.

The user has the flexibility of using these devices at either GTL ( $V_{TT}$  = 1.2 V and  $V_{REF}$  = 0.8 V) or the preferred higher noise margin GTL+ ( $V_{TT}$  = 1.5 V and  $V_{REF}$  = 1 V) signal levels. GTL+ is the Texas Instruments derivative of the Gunning Transceiver Logic (GTL) JEDEC standard JESD 8-3. The B port normally operates at GTL or GTL+ signal levels, while the A-port and control inputs are compatible with LVTTL logic levels and are 5-V tolerant.  $V_{REF}$  is the reference input voltage for the B port.

 $V_{CC}$  (5 V) supplies the internal and GTL circuitry while  $V_{CC}$  (3.3 V) supplies the LVTTL output buffers.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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## **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable(LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable (OEAB and OEBA) inputs. For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if OEAB is low and CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLKAB if OEAB also is low. When OEAB is low, the outputs are active. When OEAB is high, the outputs are in the high-impedance state. Data flow for B to A is similar to that for A to B, but uses OEBA, LEBA, CLKBA, and OEBA.

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Active bus-hold circuitry holds unused or undriven LVTTL inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

#### ORDERING INFORMATION

| T <sub>A</sub> | PACKA       | GE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|-------------------|-----------------------|------------------|
|                | SSOP – DL   | Tube              | SN74GTL16612DL        | GTL16612         |
| –40°C to 85°C  | 330P - DL   | Tape and reel     | SN74GTL16612DLR       | GILIODIZ         |
|                | TSSOP - DGG | Tape and reel     | SN74GTL16612DGGR      | GTL16612         |
| –55°C to 125°C | CFP – WD    | Tube              | SNJ54GTL16612WD       | SNJ54GTL16612WD  |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

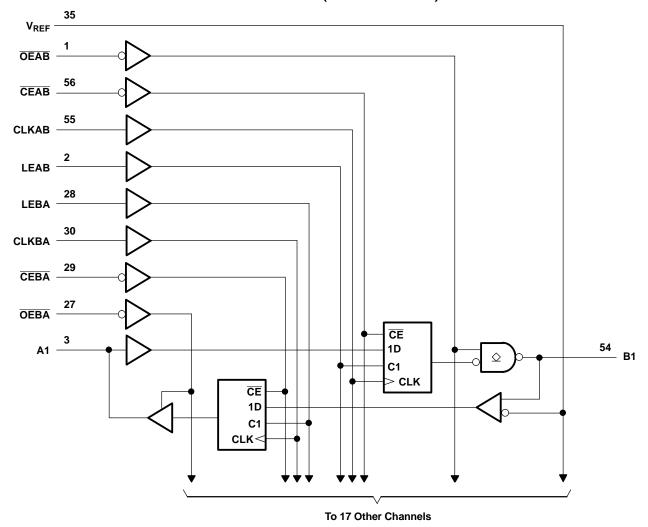
#### **FUNCTION TABLE**(1)

|      |      | INPUTS |            |   | OUTPUT                        | MODE                      |
|------|------|--------|------------|---|-------------------------------|---------------------------|
| CEAB | OEAB | LEAB   | CLKAB      | Α | В                             | MODE                      |
| Х    | Н    | Х      | Х          | Х | Z                             | Isolation                 |
| L    | L    | L      | Н          | Χ | B <sub>0</sub> <sup>(2)</sup> | Latabad atorogo of A data |
| L    | L    | L      | L          | Χ | B <sub>0</sub> (3)            | Latched storage of A data |
| Х    | L    | Н      | Х          | L | L                             | Transparent               |
| X    | L    | Н      | X          | Н | Н                             | Transparent               |
| L    | L    | L      | <b>↑</b>   | L | L                             | Classed storage of A data |
| L    | L    | L      | $\uparrow$ | Н | Н                             | Clocked storage of A data |
| Н    | L    | L      | Х          | Х | B <sub>0</sub> <sup>(3)</sup> | Clock inhibit             |

- (1) A-to-B data flow is shown. B-to-A data flow is similar, but uses OEBA, LEBA, CLKBA, and CEBA.
- (2) Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low
- (3) Output level before the indicated steady-state input conditions were established



## **LOGIC DIAGRAM (POSITIVE LOGIC)**



3

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## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |  |                             | MIN  | MAX  | UNIT     |
|------------------|--|-----------------------------|------|------|----------|
| 1/               | Cumply voltage range   | 3.3 V                       | -0.5 | 4.6  | V        |
| $V_{CC}$         | Supply voltage range   | 5 V                         | -0.5 | 7    | V        |
| \/               | Input voltage range(2)   | A-port and control inputs   | -0.5 | 7    | V        |
| VI               | Input voltage range (2)  | B port and V <sub>REF</sub> | -0.5 | 4.6  | V        |
| \/               | Valtage range applied to any output in the high or never off state (2) | A port                      | -0.5 | 7    | V        |
| Vo               | Voltage range applied to any output in the high or power-off state (2) | B port                      | -0.5 | 4.6  | V        |
|                  | Company into any autout in the law state                               | A port                      |      | 128  | Л        |
| I <sub>O</sub>   | Current into any output in the low state                               | B port                      |      | 80   | mA       |
| Io               | Current into any A-port output in the high state <sup>(3)</sup>        |                             |      | 64   | mA       |
|                  | Continuous current through each V <sub>CC</sub> or GND                 |                             |      | ±100 | mA       |
| I <sub>IK</sub>  | Input clamp current  | V <sub>I</sub> < 0          |      | -50  | mA       |
| I <sub>OK</sub>  | Output clamp current   | V <sub>O</sub> < 0          |      | -50  | mA       |
| 0                | Declare thermal impadence (4)  | DGG package                 |      | 64   | °C // // |
| $\theta_{JA}$    | Package thermal impedance (4)  | DL package                  |      | 56   | °C/W     |
| T <sub>stg</sub> | Storage temperature range  | ·                           | -65  | 150  | °C       |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# Recommended Operating Conditions (1)(2)(3)(4)

|                 |                           |               | SN54                     | GTL16 | 612                      | SN74                     | GTL166 | 12                       |      |
|-----------------|---------------------------|---------------|--------------------------|-------|--------------------------|--------------------------|--------|--------------------------|------|
|                 |                           |               | MIN                      | NOM   | MAX                      | MIN                      | NOM    | MAX                      | UNIT |
| V               | Cupalyyaltaga             | 3.3 V         | 3.15                     | 3.3   | 3.45                     | 3.15                     | 3.3    | 3.45                     | V    |
| V <sub>CC</sub> | Supply voltage            | 5 V           | 4.75                     | 5     | 5.25                     | 4.75                     | 5      | 5.25                     | V    |
| V               | Termination               | GTL           | 1.14                     | 1.2   | 1.26                     | 1.14                     | 1.2    | 1.26                     | V    |
| V <sub>TT</sub> | voltage                   | GTL+          | 1.35                     | 1.5   | 1.65                     | 1.35                     | 1.5    | 1.65                     | V    |
| .,              | Deference voltage         | GTL           | 0.74                     | 0.8   | 0.87                     | 0.74                     | 0.8    | 0.87                     | V    |
| $V_{REF}$       | Reference voltage         | GTL+          | 0.87                     | 1     | 1.1                      | 0.87                     | 1      | 1.1                      | V    |
| .,              | Innut voltage             | B port        |                          |       | V <sub>TT</sub>          |                          |        | V <sub>TT</sub>          | V    |
| VI              | Input voltage             | Except B port |                          |       | 5.5                      |                          |        | 5.5                      | V    |
| V               | High-level                | B port        | V <sub>REF</sub> + 50 mV |       |                          | V <sub>REF</sub> + 50 mV |        |                          | V    |
| V <sub>IH</sub> | input voltage             | Except B port | 2                        |       |                          | 2                        |        |                          | V    |
| .,              | Low-level                 | B port        |                          |       | V <sub>REF</sub> – 50 mV |                          |        | V <sub>REF</sub> – 50 mV | V    |
| $V_{IL}$        | input voltage             | Except B port |                          |       | 0.8                      |                          |        | 0.8                      | V    |
| I <sub>IK</sub> | Input clamp current       |               |                          |       | -18                      |                          |        | -18                      | mA   |
| I <sub>OH</sub> | High-level output current | A port        |                          |       | -32                      |                          |        | -32                      | mA   |
|                 | Low-level                 | A port        |                          |       | 64                       |                          |        | 64                       | A    |
| I <sub>OL</sub> | output current            | B port        |                          |       | 40                       |                          |        | 40                       | mA   |
| T <sub>A</sub>  | Operating free-air te     | mperature     | -55                      |       | 125                      | -40                      |        | 85                       | °C   |

<sup>(1)</sup> All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

This current flows only when the output is in the high state and  $V_O > V_{CC}$ .

The package thermal impedance is calculated in accordance with JESD 51-7.

Normal connection sequence is GND first,  $V_{CC}$  = 5 V second, and  $V_{CC}$  = 3.3 V, I/O, control inputs,  $V_{TT}$  and  $V_{REF}$  (any order) last.  $V_{TT}$  and  $R_{TT}$  can be adjusted to accommodate backplane impedances if the dc recommended  $I_{OL}$  ratings are not exceeded.

V<sub>REF</sub> can be adjusted to optimize noise margins, but normally is two-thirds V<sub>TT</sub>.



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#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| DADA                            | METER  | TEST CONDI   | TIONS  | SN54G                            | TL16612            | 2          | SN74G                            | TL16612                  | 2    | UNIT |
|---------------------------------|--|--|--|----------------------------------|--------------------|------------|----------------------------------|--------------------------|------|------|
| PARA                            | NIVIETER   | TEST CONDI   | IIONS  | MIN                              | TYP <sup>(1)</sup> | MAX        | MIN                              | N TYP <sup>(1)</sup> MAX |      | UNIT |
| V <sub>IK</sub>                 |  | V <sub>CC</sub> (3.3 V) = 3.15 V,<br>V <sub>CC</sub> (5 V) = 4.75 V                              | I <sub>I</sub> = -18 mA                                |                                  |                    | -1.2       |                                  |                          | -1.2 | V    |
| V <sub>OH</sub>                 | A port   | $V_{CC}$ (3.3 V) = 3.15 V to 3.45 V, $V_{CC}$ (5 V) = 4.75 V to 5.25 V                           | I <sub>OH</sub> = -100 μA                              | V <sub>CC</sub> (3.3 V)<br>- 0.2 |                    |            | V <sub>CC</sub> (3.3 V)<br>- 0.2 |                          |      | V    |
| ·OH                             | 7. 60.0  | $V_{CC}$ (3.3 V) = 3.15 V,   | $I_{OH} = -8 \text{ mA}$                               | 2.4                              |                    |            | 2.4                              |                          |      |      |
|                                 |  | $V_{CC}$ (5 V) = 4.75 V  | $I_{OH} = -32 \text{ mA}$                              | 2                                |                    |            | 2                                |                          |      |      |
|                                 |  |  | $I_{OL} = 100 \mu A$                                   |                                  |                    | 0.2        |                                  |                          | 0.2  |      |
|                                 | A port   | $V_{CC}$ (3.3 V) = 3.15 V,   | $I_{OL} = 16 \text{ mA}$                               |                                  |                    | 0.4        |                                  |                          | 0.4  |      |
| $V_{OL}$                        | A port   | $V_{CC}$ (5 V) = 4.75 V  | $I_{OL} = 32 \text{ mA}$                               |                                  |                    | 0.5        |                                  |                          | 0.5  | V    |
| OL                              |  |  | $I_{OL} = 64 \text{ mA}$                               |                                  |                    | 0.6        |                                  |                          | 0.55 |      |
|                                 | B port   | $V_{CC}$ (3.3 V) = 3.15 V, $V_{CC}$ (5 V $I_{OL}$ = 40 mA  | ') = 4.75 V,   |                                  |                    | 0.5        |                                  |                          | 0.4  |      |
|                                 | Control inputs   | $V_{CC}$ (3.3 V) = 0 or 3.45 V,<br>$V_{CC}$ (5 V) = 0 or 5.25 V                                  | V <sub>I</sub> = 5.5 V                                 |                                  |                    | 10         |                                  |                          | 10   |      |
|                                 |  |  | V <sub>I</sub> = 5.5 V                                 |                                  |                    | 1000       |                                  |                          | 20   |      |
| I <sub>I</sub>                  | A port   | $V_{CC}$ (3.3 V) = 3.45 V,<br>$V_{CC}$ (5 V) = 5.25 V  | $V_{I} = V_{CC} (3.3 \text{ V})$                       |                                  |                    | 1          |                                  |                          | 1    | μА   |
| •                               |  | VCC (0 V) = 0.25 V   | $V_I = 0$  |                                  |                    | -30        |                                  |                          | -30  |      |
|                                 | B port $V_{CC} (3.3 \text{ V}) = 3.45 \text{ V},$<br>$V_{CC} (5 \text{ V}) = 5.25 \text{ V}$ |  | $V_{I} = V_{CC} (3.3 \text{ V})$                       |                                  |                    | 5          |                                  |                          | 5    |      |
|                                 |  |  | $V_1 = 0$  |                                  |                    | <b>-</b> 5 |                                  |                          | -5   |      |
| I <sub>off</sub>                |  | $V_{CC} = 0$ ,   | $V_{I}$ or $V_{O} = 0$ to 4.5 V                        |                                  |                    | 1000       |                                  |                          | 100  | μΑ   |
|                                 |  |  | V <sub>I</sub> = 0.8 V                                 | 75                               |                    |            | 75                               |                          |      |      |
| I <sub>I(hold)</sub>            | A port   | $V_{CC}$ (3.3 V) = 3.15 V,   | V <sub>I</sub> = 2 V                                   | -75                              |                    |            | -75                              |                          |      | μΑ   |
| ·I(noid)                        | 71 011   | $V_{CC}$ (5 V) = 4.75 V  | $V_1 = 0 \text{ to } V_{CC}$<br>(3.3 V) <sup>(2)</sup> |                                  |                    | ±500       |                                  |                          | ±500 | μιτ  |
|                                 | A port   | $V_{CC}$ (3.3 V) = 3.45 V, $V_{CC}$ (5 V   | ') = 5.25 V, V <sub>O</sub> = 3 V                      |                                  |                    | 1          |                                  |                          | 1    | ^    |
| l <sub>OZH</sub>                | B port   | $V_{CC}$ (3.3 V) = 3.45 V, $V_{CC}$ (5 V   | ') = 5.25 V, V <sub>O</sub> = 1.2 V                    |                                  |                    | 10         |                                  |                          | 10   | μА   |
|                                 | A port   | $V_{CC}$ (3.3 V) = 3.45 V, $V_{CC}$ (5 V   | $V = 5.25 \text{ V}, V_0 = 0.5 \text{ V}$              |                                  |                    | -1         |                                  |                          | -1   | ^    |
| I <sub>OZL</sub>                | B port   | $V_{CC}$ (3.3 V) = 3.45 V, $V_{CC}$ (5 V   | ') = 5.25 V, V <sub>O</sub> = 0.4 V                    |                                  |                    | -10        |                                  |                          | -10  | μΑ   |
|                                 | _  | $V_{CC}$ (3.3 V) = 3.45 V,   | Outputs high   |                                  |                    | 1          |                                  |                          | 1    |      |
| I <sub>CC</sub> (3.3 V)         | A or B<br>port   | $V_{CC}$ (5 V) = 5.25 V, $I_{O}$ = 0,  | Outputs low  |                                  |                    | 5          |                                  |                          | 5    | mA   |
| (0.0 1)                         | port   | $V_I = V_{CC}$ (3.3 V) or GND  | Outputs disabled                                       |                                  |                    | 1          |                                  |                          | 1    |      |
|                                 |  | V <sub>CC</sub> (3.3 V) = 3.45 V,  | Outputs high   |                                  |                    | 120        |                                  |                          | 120  |      |
| I <sub>CC</sub><br>(5 V)        | A or B   | $V_{CC}$ (5 V) = 5.25 V, $I_{O}$ = 0,  | Outputs low  |                                  |                    | 120        |                                  |                          | 120  | mA   |
| (5 V)                           | port   | $V_I = V_{CC}$ (3.3 V) or GND  | Outputs disabled                                       |                                  |                    | 120        |                                  |                          | 120  |      |
| ΔI <sub>CC</sub> <sup>(3)</sup> |  | $V_{CC}$ (3.3 V) = 3.45 V, $V_{CC}$ (5 V A-port or control inputs at $V_{CC}$ One input at 2.7 V | () = 5.25 V,<br>(3.3 V) or GND,                        |                                  |                    | 1          |                                  |                          | 1    | mA   |
| C <sub>i</sub>                  | Control inputs   | V <sub>I</sub> = 3.15 V or 0   |  |                                  | 3.5                | 12         |                                  | 3.5                      |      | pF   |
| C.                              | A port   | V <sub>O</sub> = 3.15 V or 0   |  |                                  | 12                 | 18         |                                  | 12                       |      | nE   |
| $C_{io}$                        | B port   | v <sub>0</sub> = 3.13 v 0/ 0   |  |                                  | -                  | 10         |                                  | -                        | 5    | pF   |

<sup>(1)</sup> All typical values are at  $V_{CC}$  (3.3 V) = 3.3 V,  $V_{CC}$  (5 V) = 5 V,  $T_A$  = 25°C. (2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

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#### **Timing Requirements**

over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT}$  = 1.2 V and  $V_{REF}$  = 0.8 V for GTL (unless otherwise noted) (see Figure 1)

|                    |                 |                            | SN54GTL | .16612 | SN74GTL | .16612 | UNIT |
|--------------------|-----------------|----------------------------|---------|--------|---------|--------|------|
|                    |                 |                            | MIN MAX |        | MIN     | MAX    | UNIT |
| f <sub>clock</sub> | Clock frequency |                            |         | 95     |         | 95     | MHz  |
|                    | Pulse duration  | LEAB or LEBA high          | 3.3     |        | 3.3     |        | no   |
| t <sub>w</sub>     | Pulse duration  | CLKAB or CLKBA high or low | 5.6     |        | 5.6     |        | ns   |
|                    |                 | A before CLKAB↑            | 1.3     |        | 1.3     |        |      |
|                    |                 | B before CLKBA↑            | 3.4     |        | 2.5     |        |      |
|                    | Setup time      | A before LEAB↓             | 1.2     |        | 0       |        |      |
| t <sub>su</sub>    | Setup time      | B before LEBA↓             | 1       |        | 1       |        | ns   |
|                    |                 | CEAB before CLKAB↑         | 2.1     |        | 2       |        |      |
|                    |                 | CEBA before CLKBA↑         | 2.6     |        | 2.2     |        |      |
|                    |                 | A after CLKAB↑             | 2.9     |        | 1.6     |        |      |
|                    |                 | B after CLKBA↑             | 4.1     |        | 0.3     |        |      |
|                    | Hald time       | A after LEAB↓              | 4.5     |        | 4       |        |      |
| t <sub>h</sub>     | Hold time       | B after LEBA↓              | 4.3     |        | 3.6     |        | ns   |
|                    |                 | CEAB after CLKAB↑          | 2       |        | 0.8     |        |      |
|                    |                 | CEBA after CLKBA↑          | 1.1     |        | 1.1     |        |      |

#### **Switching Characteristics**

over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT}$  = 1.2 V and  $V_{REF}$  = 0.8 V for GTL (see Figure 1)

| DADAMETED        | FROM                 | то                    | SNS | 54GTL166           | 612 | SN7 | 4GTL16             | 612 | UNIT |
|------------------|----------------------|-----------------------|-----|--------------------|-----|-----|--------------------|-----|------|
| PARAMETER        | (INPUT)              | (OUTPUT)              | MIN | TYP <sup>(1)</sup> | MAX | MIN | TYP <sup>(1)</sup> | MAX | UNIT |
| f <sub>max</sub> |                      |                       | 95  |                    |     | 95  |                    |     | MHz  |
| t <sub>PLH</sub> | А                    | В                     | 1   | 2.8                | 4.5 | 1.5 | 2.8                | 4.1 | ns   |
| t <sub>PHL</sub> | Α                    | В                     | 1   | 2.5                | 4.5 | 1.3 | 2.5                | 4   | 115  |
| t <sub>PLH</sub> | LEAB                 | В                     | 1   | 3.6                | 5.5 | 2   | 3.6                | 5.3 | ns   |
| t <sub>PHL</sub> | LEAD                 | Ь                     | 1   | 3.5                | 6   | 1.9 | 3.5                | 5.4 | 115  |
| t <sub>PLH</sub> | CLKAB                | В                     | 1   | 3.7                | 5.5 | 2.3 | 3.7                | 5.3 | ns   |
| t <sub>PHL</sub> | CLNAD                | В                     | 1   | 3.4                | 5.5 | 1.9 | 3.4                | 5.4 | 115  |
| t <sub>en</sub>  | <del>OEAB</del>      | В                     | 1   | 3.3                | 5.5 | 2   | 3.3                | 5.5 | ns   |
| t <sub>dis</sub> | OEAB                 | Б                     | 1   | 3.4                | 5.5 | 2   | 3.4                | 5.1 | 115  |
| t <sub>r</sub>   | Transition time, B o | utputs (0.5 V to 1 V) |     | 1.3                |     |     | 1.3                |     | ns   |
| t <sub>f</sub>   | Transition time, B o | utputs (1 V to 0.5 V) |     | 0.5                |     |     | 0.5                |     | ns   |
| t <sub>PLH</sub> | В                    | Α                     | 2   | 4.1                | 6.9 | 2.1 | 4.1                | 6.3 | ns   |
| t <sub>PHL</sub> | Ь                    | ^                     | 1   | 2.9                | 5.1 | 1.2 | 2.9                | 4.6 | 115  |
| t <sub>PLH</sub> | LEBA                 | Α                     | 2   | 3.7                | 6.1 | 2.3 | 3.7                | 5.7 | 20   |
| t <sub>PHL</sub> | LEDA                 | A                     | 1   | 3                  | 5.1 | 1.8 | 3                  | 4.8 | ns   |
| t <sub>PLH</sub> | CLICDA               | Α                     | 2   | 3.8                | 6.4 | 2.5 | 3.8                | 6.1 | 20   |
| t <sub>PHL</sub> | CLKBA                | A                     | 2   | 3.3                | 5.6 | 2.3 | 3.3                | 5.2 | ns   |
| t <sub>en</sub>  | <u>OEBA</u>          | А                     | 1   | 5                  | 7.5 | 2.3 | 5                  | 7.4 | nc   |
| t <sub>dis</sub> | OEBA                 | A                     | 2   | 4.3                | 6.9 | 2.5 | 4.3                | 6.4 | ns   |

<sup>(1)</sup> All typical values are at  $V_{CC}$  (3.3 V) = 3.3 V,  $V_{CC}$  (5 V) = 5 V,  $T_A$  = 25°C.



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#### **Timing Requirements**

over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT}$  = 1.5 V and  $V_{REF}$  = 1 V for GTL+ (unless otherwise noted) (see Figure 1)

|                    |                 |                            | SN54GTL | .16612 | SN74GTL | .16612 | UNIT |
|--------------------|-----------------|----------------------------|---------|--------|---------|--------|------|
|                    |                 |                            | MIN     | MAX    | MIN     | MAX    | UNIT |
| f <sub>clock</sub> | Clock frequency |                            |         | 95     |         | 95     | MHz  |
|                    | Pulse duration  | LEAB or LEBA high          | 3.3     |        | 3.3     |        | ns   |
| t <sub>w</sub>     | Pulse duration  | CLKAB or CLKBA high or low | 5.6     |        | 5.6     |        | ns   |
|                    |                 | A before CLKAB↑            | 1.3     |        | 1.3     |        |      |
|                    |                 | B before CLKBA↑            | 3.2     |        | 2.3     |        |      |
|                    | Setup time      | A before LEAB↓             | 1.2     |        | 0       |        |      |
| t <sub>su</sub>    | Setup time      | B before LEBA↓             | 1.3     |        | 1.3     |        | ns   |
|                    |                 | CEAB before CLKAB↑         | 2.1     |        | 2       |        |      |
|                    |                 | CEBA before CLKBA↑         | 2.6     |        | 2.2     |        |      |
|                    |                 | A after CLKAB↑             | 2.9     |        | 1.6     |        |      |
|                    |                 | B after CLKBA↑             | 4.4     |        | 0.3     |        |      |
|                    | الماط فنجم      | A after LEAB↓              | 4.5     |        | 4       |        |      |
| t <sub>h</sub>     | Hold time       | B after LEBA↓              | 4.3     |        | 3.6     |        | ns   |
|                    |                 | CEAB after CLKAB↑          | 2       |        | 0.8     |        |      |
|                    |                 | CEBA after CLKBA↑          | 1.1     |        | 1.1     |        |      |

#### **Switching Characteristics**

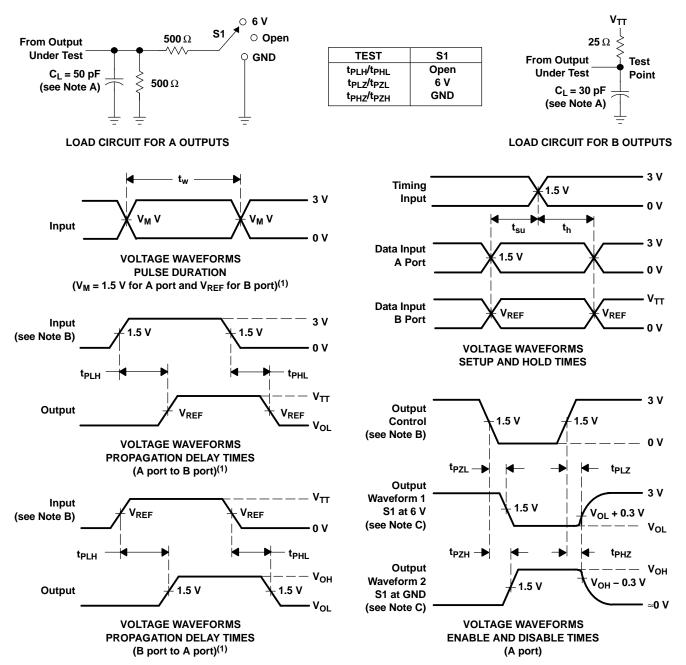
over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT}$  = 1.5 V and  $V_{REF}$  = 1 V for GTL+ (see Figure 1)

| DADAMETED        | FROM                  | то                    | SNS | 54GTL166           | 612 | SN7 | 74GTL166           | 612 | LINUT |
|------------------|-----------------------|-----------------------|-----|--------------------|-----|-----|--------------------|-----|-------|
| PARAMETER        | (INPUT)               | (OUTPUT)              | MIN | TYP <sup>(1)</sup> | MAX | MIN | TYP <sup>(1)</sup> | MAX | UNIT  |
| f <sub>max</sub> |                       |                       | 95  |                    |     | 95  |                    |     | MHz   |
| t <sub>PLH</sub> | A                     | В                     | 1   | 2.8                | 4.5 | 1.5 | 2.8                | 4.1 | ns    |
| t <sub>PHL</sub> | A                     | Ь                     | 1   | 2.5                | 4.6 | 1.3 | 2.5                | 4.1 | 115   |
| t <sub>PLH</sub> | LEAB                  | В                     | 1   | 3.6                | 5.5 | 2   | 3.6                | 5.3 | ns    |
| t <sub>PHL</sub> | LEAD                  | Б                     | 1   | 3.5                | 6.1 | 1.9 | 3.5                | 5.5 | ns    |
| t <sub>PLH</sub> | CLKAB                 | В                     | 1   | 3.7                | 5.5 | 2.3 | 3.7                | 5.3 | ns    |
| t <sub>PHL</sub> | CLNAD                 | Ь                     | 1   | 3.4                | 5.6 | 1.9 | 3.4                | 5.5 | 115   |
| t <sub>PLH</sub> | <del>OEAB</del>       | В                     | 1   | 3.4                | 5.5 | 2   | 3.4                | 5.1 | ns    |
| t <sub>PHL</sub> | OEAB                  | Ь                     | 1   | 3.3                | 5.6 | 2   | 3.3                | 5.6 | 115   |
| t <sub>r</sub>   | Transition time, B or | utputs (0.5 V to 1 V) |     | 1.5                |     |     | 1.5                |     | ns    |
| t <sub>f</sub>   | Transition time, B or | utputs (1 V to 0.5 V) |     | 8.0                |     |     | 0.8                |     | ns    |
| t <sub>PLH</sub> | В                     | А                     | 1.9 | 4                  | 6.9 | 2   | 4                  | 6.3 | ns    |
| t <sub>PHL</sub> | Б                     | A                     | 0.9 | 2.8                | 4.9 | 1.1 | 2.8                | 4.4 | 115   |
| t <sub>PLH</sub> | LEBA                  | Α                     | 2   | 3.7                | 6.1 | 2.3 | 3.7                | 5.7 | 20    |
| t <sub>PHL</sub> | LEDA                  | A                     | 1   | 3                  | 5.1 | 1.8 | 3                  | 4.8 | ns    |
| t <sub>PLH</sub> | CLKBA                 | А                     | 2   | 3.8                | 6.4 | 2.5 | 3.8                | 6.1 | nc    |
| t <sub>PHL</sub> | CLNDA                 | A                     | 2   | 3.3                | 5.6 | 2.3 | 3.3                | 5.2 | ns    |
| t <sub>en</sub>  | - OEBA                | А                     | 1   | 5                  | 7.5 | 2.3 | 5                  | 7.4 | nc    |
| t <sub>dis</sub> | UEDA                  | Α                     | 2   | 4.3                | 6.9 | 2.5 | 4.3                | 6.4 | ns    |

<sup>(1)</sup> All typical values are at  $V_{CC}$  (3.3 V) = 3.3 V,  $V_{CC}$  (5 V) = 5 V,  $T_A$  = 25°C.



# PARAMETER MEASUREMENT INFORMATION $V_{TT}$ = 1.2 V, $V_{REF}$ = 0.8 V for GTL and $V_{TT}$ = 1.5 V, $V_{REF}$ = 1 V for GTL+



(1) All control inputs are TTL levels.

NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O$  = 50  $\Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins   | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|--------|---------------|------------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
|                       | , ,    | , ,           |                  |                       | · ,  | (4)                           | (5)                        |              | , ,              |
| SN74GTL16612DGGR      | Active | Production    | TSSOP (DGG)   56 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | GTL16612         |
| SN74GTL16612DGGR.B    | Active | Production    | TSSOP (DGG)   56 | 2000   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | GTL16612         |
| SN74GTL16612DL        | Active | Production    | SSOP (DL)   56   | 20   TUBE             | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | GTL16612         |
| SN74GTL16612DL.B      | Active | Production    | SSOP (DL)   56   | 20   TUBE             | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | GTL16612         |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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# **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device           | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74GTL16612DGGR | TSSOP           | DGG                | 56 | 2000 | 330.0                    | 24.4                     | 8.9        | 14.7       | 1.4        | 12.0       | 24.0      | Q1               |

# **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

| Ì | Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ı | SN74GTL16612DGGR | TSSOP        | DGG             | 56   | 2000 | 356.0       | 356.0      | 45.0        |

# **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**



#### \*All dimensions are nominal

| Device           | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74GTL16612DL   | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74GTL16612DL.B | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |

# DL (R-PDSO-G56)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.





SMALL OUTLINE PACKAGE



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



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